# CD54HC193F3A, CD54HCT193F3A

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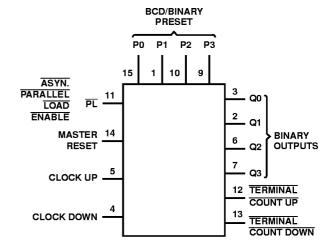
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# Presettable Synchronous Up/Down Counters

The CD54HC193F3A and CD54HCT193F3A are asynchronously presettable binary up/down synchronous counters.

Presetting the counter to the number on preset data inputs (P0 - P3) is accomplished by a LOW asychronous parallel load input (PL). The counter is incremented on the low-to-high transition of the Clock-Up input (and a high level on the Clock-Down input) and decremented on the low-to-high transition of the Clock-Down input (and a high level on the Clock-Up input). A high level on the MR input overrides any other input to clear the counter to its zero state. The Terminal Count Up (carry) goes low half a clock period before the zero count is reached and returns to a high level at the zero count. The Terminal Count Down (borrow) in the count-down mode likewise goes half a clock period before the maximum count (15 in the CD54HC/HCT193) and returns to high at the maximum count. Cascading is effected by connecting the carry and borrow outputs of a less significant counter to the Clock-Up and Clock-Down inputs, respectively, of the next most significant counter.

### Functional Diagram



#### **HCT INPUT LOAD TABLE**

INPUT	UNIT LOAD (NOTE 1)
P0 - P3	0.4
MR	1.45
PL L	0.85
CPU, CPD	1.45

#### NOTE:

#### **Absolute Maximum Ratings**

DC Supply Voltage, V <sub>CC</sub>
Voltages Referenced to GND0.5V to +7.0V
DC Input Voltage Range, All Inputs, V <sub>IN</sub> 0.5V to V <sub>CC</sub> +0.5V
DC Output Voltage Range, All Outputs, V <sub>OUT</sub> 0.5V to V <sub>CC</sub> +0.5V
DC Input Diode Current, I <sub>IK</sub>
For $V_1 < -0.5V$ or $V_1 > V_{CC} + 0.5V$ ±20mA
DC Output Diode Current, IOK
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ ±20mA
DC Drain Current, Per Output, I <sub>O</sub> , For -0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V
Standard Output±25mA
Bus Driver Output±35mA
DC V <sub>CC</sub> or GND Current, I <sub>CC</sub>
Standard Output±50mA
Bus Driver Output±70mA

Power Dissipation Per Package, P <sub>D</sub>
T <sub>A</sub> = -55°C to +100°C (Package F)
$T_A = +100^{\circ}$ C to $+125^{\circ}$ C (Package F)Derate Linearly at
8mW/ <sup>o</sup> C to 300mW
Operating Temperature Range, TA
Package Type F55°C to +125°C
Storage Temperature, T <sub>STG</sub> 65°C to +150°C
Lead Temperature (During Soldering)
At Distance 1/16in. $\pm$ 1/32in. (1.59mm $\pm$ 0.79mm)
From Case For 10s Max+265°C
Unit Inserted Into a PC Board (Min Thickness 1/16in., 1.59mm)
With Solder Contacting Lead Tips Only

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## **Recommended Operating Conditions**

Supply Voltage Range, V <sub>CC</sub>
T <sub>A</sub> = Full Package Temperature Range
CD54HC Types
CD54HCT Types
DC Input or Output Voltage, V <sub>IN</sub> , V <sub>OUT</sub>

Operating Temperature Range, T <sub>A</sub>	-55°C to +125°C
at 2V	0ns to 1000ns
at 4.5V	0ns to 500ns
at 6V	One to 400ne

<sup>1.</sup> Unit load is  $\Delta I_{CC}$  limit specified in DC Electrical Specifications Table, e.g., 360 $\mu$ A Max at +25 $^{o}$ C.